SN54ACT563, SN74ACT563 OCTAL D-TYPE TRANSPARENT LATCHES WITH 3-STATE OUTPUTS

SCAS550B - NOVEMBER 1995 - REVISED OCTOBER 2002

- 4.5-V to 5.5-V V_{CC} Operation
- Inputs Accept Voltages to 5.5 V
- Max t_{pd} of 8.5 ns at 5 V
- Inputs Are TTL-Voltage Compatible
- 3-State Inverted Outputs Drive Bus Lines Directly
- Flow-Through Architecture to Optimize PCB Layout

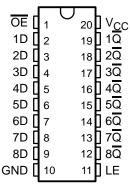
description/ordering information

The 'ACT563 devices are octal D-type transparent latches with 3-state outputs. When the latch-enable (LE) input is high, the \overline{Q} outputs are set to the complements of the data (D) inputs. When LE is taken low, the \overline{Q} outputs are latched at the inverse logic levels set up at the D inputs.

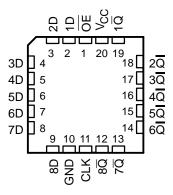
A buffered output-enable (\overline{OE}) input places the eight outputs in either a normal logic state (high or low logic levels) or the high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and increased high logic level provide the capability to drive bus lines without interface or pullup components.

OE does not affect internal operations of the latches. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

SN54ACT563 . . . J OR W PACKAGE SN74ACT563 . . . DB, DW, N, NS, OR PW PACKAGE (TOP VIEW)



SN54ACT563...FK PACKAGE (TOP VIEW)



To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

ORDERING INFORMATION

| TA | PACKAGI | ʆ | ORDERABLE PART NUMBER | TOP-SIDE MARKING | |
|----------------|-------------------------|------------------|--------------------------|---------------------|--|
| | PDIP – N | Tube SN74ACT563N | | SN74ACT563N | |
| –40°C to 85°C | SOIC - DW | Tube | SN74ACT563DW | ACT563 | |
| | 301C - DW | Tape and reel | SN74ACT563DWR | AC1505 | |
| | SOP - NS | Tape and reel | SN74ACT563NSR | ACT563 | |
| | SSOP – DB Tape and reel | | SN74ACT563DBR | AD563 | |
| | TSSOP – PW | Tape and reel | SN74ACT563PWR | AD563 | |
| | CDIP – J | Tube | SNJ54ACT5634J | SNJ54ACT563J | |
| –55°C to 125°C | CFP – W | Tube | SNJ54ACT563W | SNJ54ACT563W | |
| | LCCC - FK | Tube | SNJ54ACT563FK | SNJ54ACT563FK | |

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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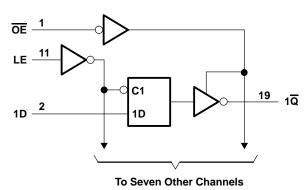


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FUNCTION TABLE (each latch)

| | INPUTS | OUTPUT | |
|---|--------|--------|------------------|
| Œ | LE | D | Q |
| L | Н | Н | L |
| L | Н | L | Н |
| L | L | Χ | \overline{Q}_0 |
| Н | Χ | Χ | Z |

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| Supply voltage range, V _{CC} | | _0.5 \/ to 7 \/ |
|--|------------|---|
| Input voltage range, V _I (see Note 1) | | |
| | | |
| Output voltage range, VO (see Note 1) | | \dots –0.5 V to V _{CC} + 0.5 V |
| Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$). | | ±20 mA |
| Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CO}$ | c) | ±20 mA |
| Continuous output current, I_O ($V_O = 0$ to V_{CC}) | | |
| Continuous current through V _{CC} or GND | | |
| Package thermal impedance, θ_{JA} (see Note 2) | | |
| , | DW package | |
| | N package | |
| | NS package | |
| | PW package | |
| Storage temperature range, T _{sta} | . • | |

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51-7.



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recommended operating conditions (see Note 3)

| | | SN54ACT | | SN74ACT563 | | UNIT |
|-----------------|------------------------------------|---------|-----|------------|-----|------|
| | | MIN | MAX | MIN | MAX | UNIT |
| VCC | Supply voltage | 4.5 | 5.5 | 4.5 | 5.5 | V |
| VIH | High-level input voltage | 2 | 7 | 2 | | V |
| V _{IL} | Low-level input voltage | | 0.8 | | 0.8 | V |
| VI | Input voltage | 0 | Vcc | 0 | VCC | V |
| ۷o | Output voltage | 0, | Vcc | 0 | VCC | ٧ |
| IOH | High-level output current | 2 | -24 | | -24 | mA |
| l _{OL} | Low-level output current | 20 | 24 | | 24 | mA |
| Δt/Δν | Input transition rise or fall rate | Q | 8 | | 8 | ns/V |
| TA | Operating free-air temperature | -55 | 125 | -40 | 85 | °C |

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| DADAMETED | TEST COMPLETIONS | | T | A = 25°0 | ; | SN54A | CT563 | SN74A | CT563 | |
|--------------------|---|-------|------|----------|-------|-------|-------|-------|-------|------|
| PARAMETER | TEST CONDITIONS | VCC | MIN | TYP | MAX | MIN | MAX | MIN | MAX | UNIT |
| | Jan - 50 uA | 4.5 V | 4.4 | 4.49 | | 4.4 | | 4.4 | | |
| | $I_{OH} = -50 \mu\text{A}$ | 5.5 V | 5.4 | 5.49 | | 5.4 | | 5.4 | | |
| Vou | 1011 - 24 mA | 4.5 V | 3.86 | | | 3.7 | | 3.76 | | V |
| VOH | I _{OH} = -24 mA | 5.5 V | 4.86 | | | 4.7 | | 4.76 | | V |
| | I _{OH} = -50 mA [†] | 5.5 V | | | | 3.85 | 4 | | | |
| | $I_{OH} = -75 \text{ mA}^{\dagger}$ | 5.5 V | | | | | 7 | 3.85 | | |
| | I _{OL} = 50 μA | 4.5 V | | 0.001 | 0.1 | | 0.1 | | 0.1 | V |
| | ΙΟΣ = 30 μΑ | 5.5 V | | 0.001 | 0.1 | | 0.1 | | 0.1 | |
| \/a. | I _{OL} = 24 mA | 4.5 V | | | 0.36 | 2 | 0.5 | | 0.44 | |
| VOL | | 5.5 V | | | 0.36 | 30 | 0.5 | | 0.44 | |
| | I _{OL} = 50 mA [†] | 5.5 V | | | | 40 | 1.65 | | | |
| | I _{OL} = 75 mA [†] | 5.5 V | | | | | | | 1.65 | |
| loz | $V_O = V_{CC}$ or GND | 5.5 V | | | ±0.25 | | ±5 | | ±2.5 | μΑ |
| lį | $V_I = V_{CC}$ or GND | 5.5 V | | | ±0.1 | | ±1 | | ±1 | μΑ |
| Icc | $V_I = V_{CC}$ or GND, $I_O = 0$ | 5.5 V | | | 4 | | 80 | | 40 | μΑ |
| Δl _{CC} ‡ | One input at 3.4 V, Other inputs at GND or V _{CC} | 5.5 V | | 0.6 | | | 1.6 | | 1.5 | mA |
| C _i | $V_I = V_{CC}$ or GND | 5 V | | 4.5 | | | | | · | pF |

[†] Not more than one output should be tested at a time, and the duration of the test should not exceed 2 ms.

timing requirements over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

| | | T _A = 25°C | | SN54ACT563 | SN74ACT563 | | UNIT |
|-----------------|-----------------------------|-----------------------|-----|------------|------------|-----|------|
| | | MIN | MAX | MINO MAX | MIN | MAX | UNIT |
| t _W | Pulse duration, LE high | 3 | | 5 | 3 | | ns |
| t _{su} | Setup time, data before LE↓ | 4 | | 4.5 | 4.5 | | ns |
| t _h | Hold time, data after LE↓ | 0 | | 1.5 | 0 | | ns |



[‡] This is the increase in supply current for each input that is at one of the specified TTL voltage levels, rather than 0 V or VCC.

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switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

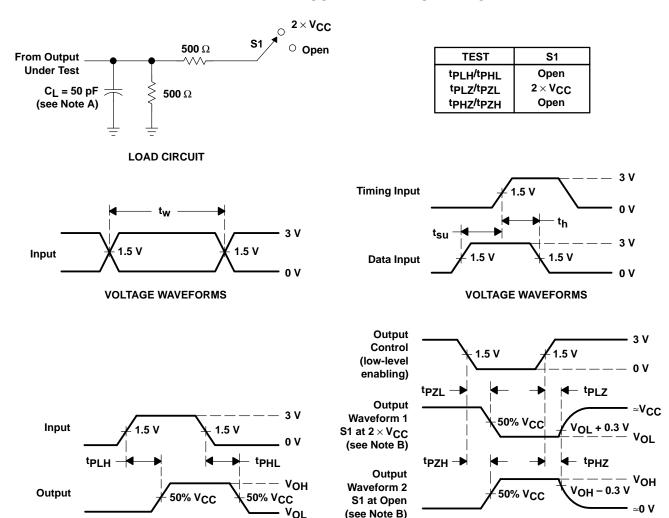
| PARAMETER | FROM | то | T _A = 25°C | | | SN54ACT563 | | SN74ACT563 | | UNIT |
|------------------|---------|----------|-----------------------|-----|------|----------------|------|------------|------|------|
| PARAMETER | (INPUT) | (OUTPUT) | MIN | TYP | MAX | MIN | MAX | MIN | MAX | UNIT |
| ^t PLH | D | Īα | 3 | 7 | 11.5 | 1 | 14.5 | 2.5 | 12.5 | |
| ^t PHL | D | σ | 3 | 6 | 10 | 1 | 12 | 2.5 | 11 | ns |
| ^t PLH | LE | Ια | 3 | 6.5 | 10.5 | 1 | 12.5 | 2.5 | 11.5 | ns |
| ^t PHL | LL | g | 2.5 | 5.5 | 9.5 | 1, | 11.5 | 2 | 10.5 | 115 |
| ^t PZH | - | lα | 2.5 | 5.5 | 9 | ₽, | 11.5 | 2 | 10 | 2 |
| ^t PZL | ŌĒ | α | 2 | 5.5 | 8.5 | O _C | 11 | 2 | 9.5 | ns |
| ^t PHZ | ŌĒ | ĪQ | 3.5 | 6.5 | 10.5 | 2 1 | 12 | 2.5 | 11.5 | ns |
| t _{PLZ} | OE . | y | 2 | 4.5 | 8 | 1 | 9.5 | 1 | 8.5 | 115 |

operating characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

| | PARAMETER | TEST CON | TYP | UNIT | |
|-----------------|-------------------------------|-------------------------|-----------|------|----|
| C _{pd} | Power dissipation capacitance | C _L = 50 pF, | f = 1 MHz | 50 | pF |

VOLTAGE WAVEFORMS

PARAMETER MEASUREMENT INFORMATION



NOTES: A. CL includes probe and jig capacitance.

VOLTAGE WAVEFORMS

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_O = 50 \Omega$, $t_f \leq$ 2.5 ns, $t_f \leq$ 2.5 ns.
- D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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PACKAGING INFORMATION

| Orderable part number | Status | Material type | Package Pins | Package qty Carrier | RoHS | Lead finish/ Ball material | MSL rating/ Peak reflow | Op temp (°C) | Part marking |
|-----------------------|----------|---------------|-----------------|-----------------------|------|-------------------------------|----------------------------|--------------|--------------|
| | (1) | (2) | | | (3) | (4) | (5) | | (6) |
| SN74ACT563DW | Obsolete | Production | SOIC (DW) 20 | - | - | Call TI | Call TI | -40 to 85 | ACT563 |
| SN74ACT563DWR | Active | Production | SOIC (DW) 20 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | ACT563 |
| SN74ACT563DWR.A | Active | Production | SOIC (DW) 20 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | ACT563 |
| SN74ACT563N | Active | Production | PDIP (N) 20 | 20 TUBE | Yes | NIPDAU | N/A for Pkg Type | -40 to 85 | SN74ACT563N |
| SN74ACT563N.A | Active | Production | PDIP (N) 20 | 20 TUBE | Yes | NIPDAU | N/A for Pkg Type | -40 to 85 | SN74ACT563N |
| SN74ACT563PW | Obsolete | Production | TSSOP (PW) 20 | - | - | Call TI | Call TI | -40 to 85 | AD563 |
| SN74ACT563PWR | Active | Production | TSSOP (PW) 20 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | AD563 |
| SN74ACT563PWR.A | Active | Production | TSSOP (PW) 20 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | AD563 |

⁽¹⁾ Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

PACKAGE OPTION ADDENDUM

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





| A0 | Dimension designed to accommodate the component width |
|----|---|
| В0 | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|---------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| SN74ACT563DWR | SOIC | DW | 20 | 2000 | 330.0 | 24.4 | 10.8 | 13.3 | 2.7 | 12.0 | 24.0 | Q1 |
| SN74ACT563PWR | TSSOP | PW | 20 | 2000 | 330.0 | 16.4 | 6.95 | 7.0 | 1.4 | 8.0 | 16.0 | Q1 |

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*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|---------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74ACT563DWR | SOIC | DW | 20 | 2000 | 356.0 | 356.0 | 45.0 |
| SN74ACT563PWR | TSSOP | PW | 20 | 2000 | 353.0 | 353.0 | 32.0 |

PACKAGE MATERIALS INFORMATION

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TUBE



*All dimensions are nominal

| Device | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (µm) | B (mm) |
|---------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| SN74ACT563N | N | PDIP | 20 | 20 | 506 | 13.97 | 11230 | 4.32 |
| SN74ACT563N.A | N | PDIP | 20 | 20 | 506 | 13.97 | 11230 | 4.32 |

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Last updated 10/2025